ABSOCIATION CONNECTING ELECTRANCE INDUSTRIES	ockburn, Illinois, A	Il rights reserved untions.	Inder both	This docume evel parts, th	ent is a declarat he declaration of	ion of the su	ubstances s all lowe	within the ma r level materi	anufacturer als for whic	listed item. N ch the manufa	Note: if th acturer ha	e item is an as s engineering	sembly with lowe responsibility.
	IPC Web Site for Information on IPC-1752 StandardForm Typhttp://www.ipc.org/IPC-175xDistribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information								
Supplier Information													
bompany name* Company unique ID				Unique ID Authority				Response Date*					
onsemi	ui									2025-06-04			
Contact Name	Title - Contact			1	Phone - Contact*				I	Email - Contact*			
Product-Env-Stewards	uct-Env-Stewards Product Enviro Compliance			NA]	Product-Env-Stewards@onsemi.com				
uthorized Representative* Title - Representative				Phone - Representative*				I	Email - Representative*				
Product-Env-Stewards Product Enviro Compliance				NA				1	Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr	Item Number	Mfr Item Name			Effective Date	Version	1	Manufacturing Site		Weigh	nt*	UOM	Unit Type
MM	ISZ5257ET1G ZENER REGUL		ATOR DIODE	COR DIODE 2			(CN1		11.525	5	mg	Each
Manufacturing Proccess Information					·							·	· · ·
Terminal Plating / Grid Array Material	Terminal Base Alloy J-S		J-STD-020 MSL	Rating	Peak Process Body		ly Temperature Max Time at Peak		e at Peak To	Temperature Number of Reflow Cycles		eles	
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30		seconds	3		
Comments													
evel 1 - maximum time at peak temperature durin	g soldering is 10-3	0 seconds											
or more information regarding material composi	tion please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	HS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl halate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.88	mg	Supplier	Silicon (Si)	7440-21-3		0.88	mg
Lead Frame	3.19	mg	В	Nickel (Ni)	7440-02-0		1.158	mg
			Supplier	Iron (Fe)	7439-89-6		1.6014	mg
			Supplier	Copper (Cu)	7440-50-8		0.4306	mg
Mold Compound-Black	6.51	mg	Supplier	Boron zinc hydroxide oxide	138265-88-0		0.1953	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		0.0325	mg
			Supplier	2,4,6-triamino-s-triazincompd.withs- triazine-triol	37640-57-6		0.1953	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		5.208	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0651	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.5208	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.2929	mg
Plating	0.8	mg	Supplier	Tin (Sn)	7440-31-5		0.8	mg
Wire Bond	0.145	mg	Supplier	Palladium (Pd)	7440-05-3		0.0019	mg
			Supplier	Copper (Cu)	7440-50-8		0.1431	mg